



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : OU et al.  
Application No. : 10/075,226  
Filed : February 15, 2002  
Title : THERMALLY ENHANCED SEMICONDUCTOR  
BUILD-UP PACKAGE  
Group Art Unit : 2831  
Examiner : H. Ngo  
Docket No. : BHT/3183-39

Honorable Commissioner of Patents  
Washington, DC 20231

**TRANSMITTAL COVER SHEET**

Sir:

Transmitted herewith for filing are the following:

1. AMENDMENT - in response to Office Action of December 20, 2002.
2. Petition for One-Month Extension of Time and  
check for \$110.

The Commissioner is hereby authorized to charge any fees which may be  
required for the filing of this document to Deposit Account No. 501874.

Respectfully submitted,

Date: April 21, 2003

By:

  
Bruce H. Troxell  
Reg. No. 26,592

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Honorable Commissioner for Patents  
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**AMENDMENT**

Sir:

In response to the Office Action of December 20, 2002, the period for response to which has been extended to expire on **April 20, 2003** by the filing herewith of a petition for a one-month extension of time and payment of the requisite fee, please amend the above-identified application as follows:

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